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RL78/G11

A/D Converter (Software Trigger and Sequential Conversion Modes) CC-RL

Introduction

This application note describes the procedures for performing A/D conversion on analog voltages using the RL78/G11's A/D converter (supporting software trigger and sequential conversion modes).

The sample program discussed in this application note performs data conversion on the A/D conversion results and places the converted values in the RL78/G11's internal RAM.

Target Device

RL78/G11

When applying the sample program covered in this application note to another microcomputer, modify the program according to the specifications for the target microcomputer and conduct an extensive evaluation of the modified program.

Contents

1. Specification

This application note provides examples of using the software trigger and sequential conversion modes of the A/D converter. The A/D converter is placed in select mode and the analog signal input from the P20/ANI0 pin is converted to digital values. Subsequently, the conversion result is subjected to data conversion (shifting the data to the right) and the result is stored in the RL78/G11's internal RAM.

Table 1.1 lists the Peripheral Function to be Used and its Use and Figure 1.1 shows the outline of the conversion operation of the A/D converter.

Table 1.1 Peripheral Function to be Used and its Use

Peripheral Function	Use
A/D converter	Converts the level of the analog signal input from the P20/ANI0 pin.

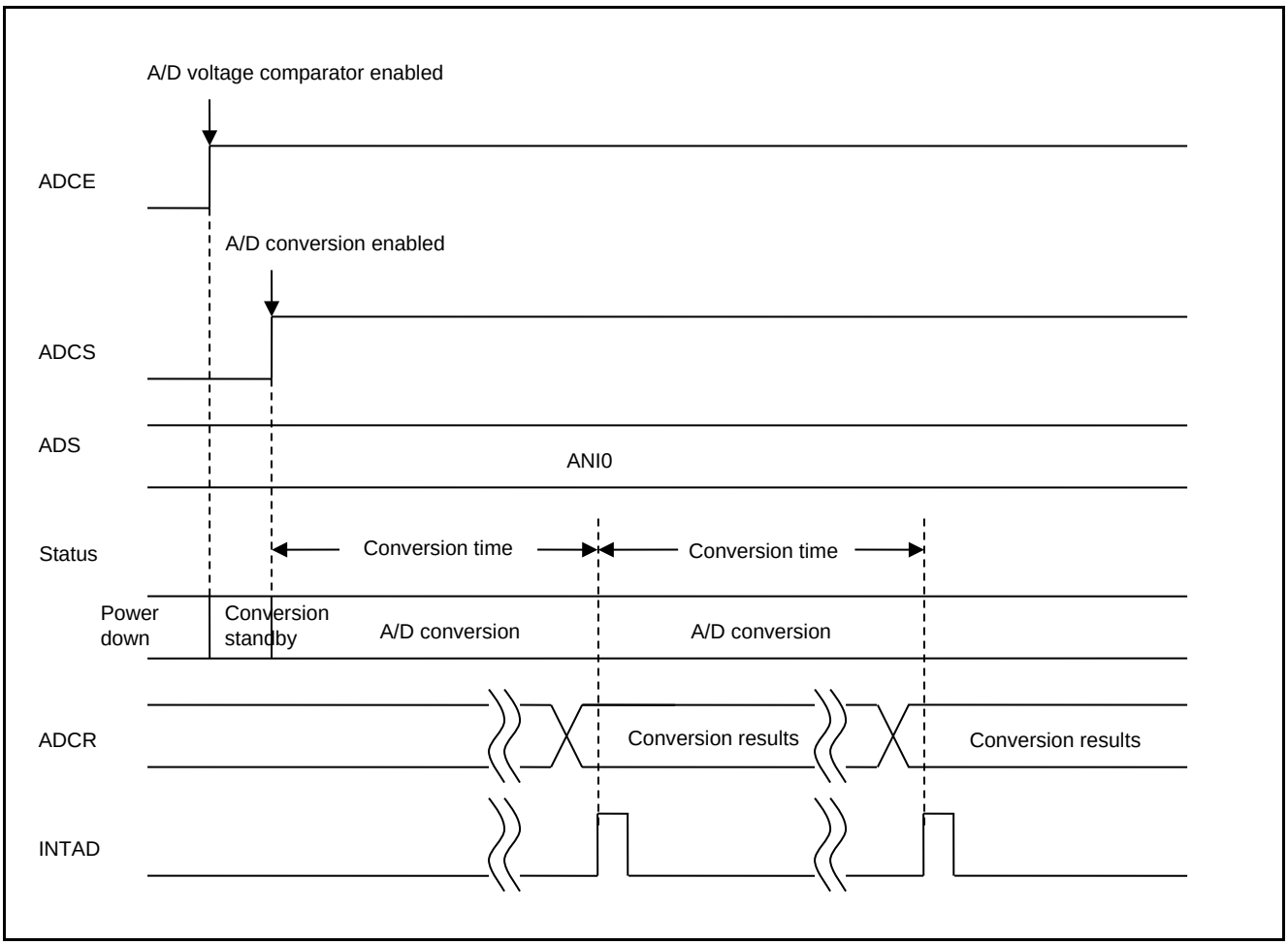

Figure 1.1 Outline of the A/D Converter Conversion Processing

2. Operation Check Conditions

The sample code contained in this application note has been checked under the conditions listed in the table below.

Table 2.1 Operation Check Conditions

Item	Description
Microcontroller used	RL78/G11 (R5F1056A)
Operating frequency	• High-speed on-chip oscillator (HOCO) clock: 24 MHz • CPU/peripheral hardware clock: 24 MHz
Operating voltage	5.0 V (can run on a voltage range of 2.7 V to 5.5 V.) LVD operation (V_{LVD}): Reset mode 2.65 V (2.65 V to 2.71V)
Integrated development environment (CS+)	CS+ for CC V4.01.00 from Renesas Electronics Corp.
C compiler (CS+)	CC-RL V1.03.00 from Renesas Electronics Corp.
Integrated development environment (e^2 studio)	e^2 studio V5.2.0.020 from Renesas Electronics Corp.
C compiler (e^2 studio)	CC-RL V1.03.00 from Renesas Electronics Corp.

3. Related Application Note

The application note that is related to this application note is listed below for reference.

- RL78/G13 A/D Converter (Software Trigger and Sequential Conversion Modes) CC-RL (R01AN2581E) Application Note

4. Description of the Hardware

4.1 Hardware Configuration Example

Figure 4.1 shows an example of hardware configuration that is used for this application note.

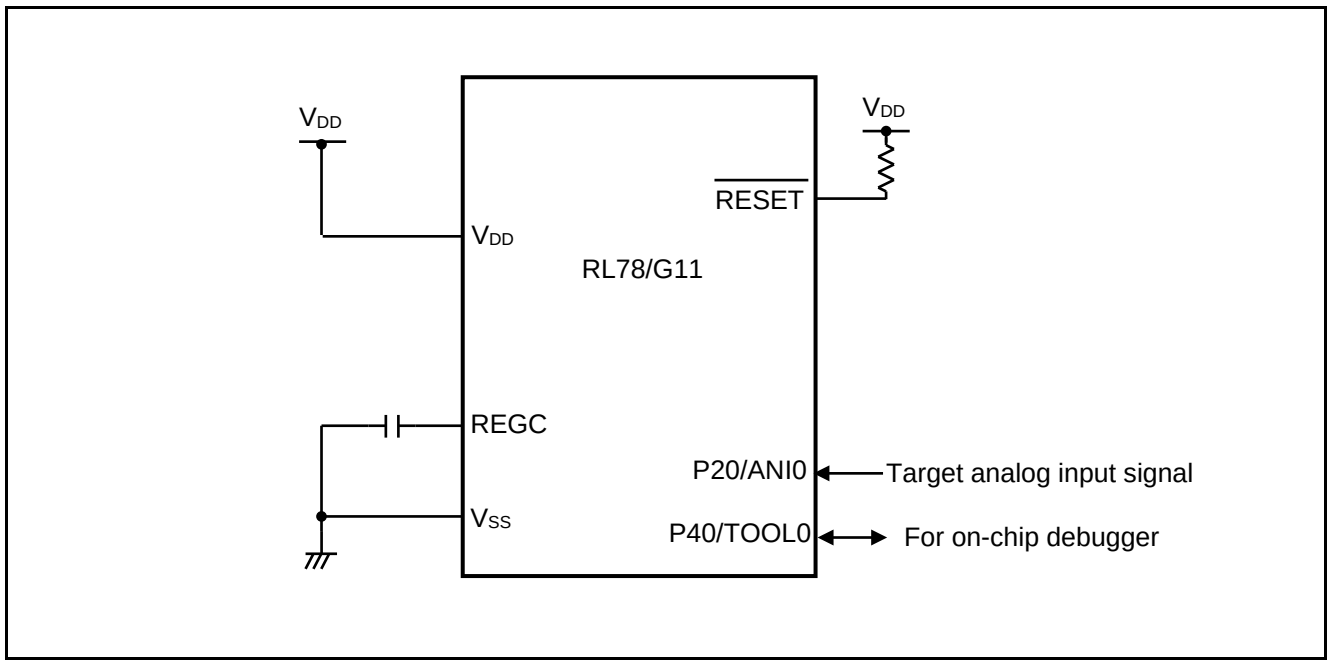

Figure 4.1 Hardware Configuration

Notes: 1. The purpose of this circuit is only to provide the connection outline and the circuit is simplified accordingly. When designing and implementing an actual circuit, provide proper pin treatment and make sure that the hardware's electrical specifications are met (connect the input-dedicated ports separately to V_{DD} or V_{SS} via a resistor).

2. V_{DD} must be held at not lower than the reset release voltage (V_{LVD}) that is specified as LVD.

4.2 List of Pins to be Used

Table 4.1 lists the pins to be used and their function.

Table 4.1 Pin to be Used and its Function

Pin Name	I/O	Description
P20/ANI0	Input	A/D converter analog input port

5. Description of the Software

5.1 Operation Outline

This sample code performs A/D conversion on the analog voltage that is input to pin ANI0 using the software trigger and sequential conversion modes of the A/D converter. It awaits the end of A/D conversion in HALT mode. After A/D conversion is completed, the sample code shifts the result of A/D conversion 6 bits to the right and places the result in the internal RAM of the RL78/G11.

(1) Initialize the A/D converter.
<Setup conditions>

- Pin P20/ANI0 is used for the analog input.
- A/D conversion channel selection mode is set to select mode.
- A/D conversion operation mode is set to sequential conversion mode.
- A/D conversion is started using the software trigger.
- The A/D conversion end interrupt (INTAD) is used.

(2) The sample program sets the ADCS bit of the ADM0 register to 1 (A/D conversion start) to start A/D conversion and executes the HALT instruction to place the chip in the HALT mode and wait for an A/D conversion end interrupt.

(3) After completing the A/D conversion of the voltage input from pin ANI0, the A/D converter transfers the result of A/D conversion to the ADCR register and generates an A/D conversion end interrupt.

(4) On release from the HALT mode in response to the A/D conversion end interrupt, the sample program reads the result of A/D conversion from the ADCR register, shifts the result 6 bits to the right, and stores the shifted data in the internal RAM of the RL78/G13.

(5) The chip returns to the HALT mode and waits for an A/D conversion end interrupt.

5.2 List of Option Byte Settings

Table 5.1 summarizes the settings of the option bytes.

Table 5.1 Option Byte Settings

Address	Value	Description
000C0H/010C0H	01101110B	Disables the watchdog timer. (Stops counting after the release of the reset state.)
000C1H/010C1H	01111111B	LVD reset mode, 2.75 V (2.75V to 2.81V)
000C2H/010C2H	11100000B	HS mode HOCO: 24 MHz
000C3H/010C3H	10000100B	Enables the on-chip debugger.

5.3 List of Variables

Table 5.2 lists the global variable that is used by this sample program.

Table 5.2 Global Variable

Type	Variable Name	Contents	Function Used
unsigned short	g_result_buffer	Area for storing the A/D conversion results	main ()

5.4 List of Functions

Table 5.3 lists the functions that are used by this sample program.

Table 5.3 Functions

Function Name	Outline
R_ADC_Set_OperationOn	Enables the A/D voltage comparator.
R_ADC_Start	Starts A/D conversion.
R_ADC_Get_Result	Gets A/D conversion results.

5.5 Function Specifications

This section describes the specifications for the functions that are used in the sample code.

[Function Name] R_ADC_Set_OperationOn	
Synopsis	Enable A/D voltage comparator.
Header	r_cg_adc.h
Declaration	void R_ADC_Set_OperationOn (void)
Explanation	Enables the A/D voltage comparator for operation.
Arguments	None
Return value	None
Remarks	None

[Function Name] R_ADC_Start	
Synopsis	Start A/D conversion.
Header	r_cg_adc.h
Declaration	void R_ADC_Start (void)
Explanation	Enables A/D conversion end interrupts and starts A/D conversion processing.
Arguments	None
Return value	None
Remarks	None

[Function Name] R_ADC_Get_Result	
Synopsis	Get A/D conversion results.
Header	r_cg_adc.h
Declaration	void R_ADC_Get_Result (uint16_t *const buffer)
Explanation	Shifts the A/D conversion results 6 bits to the right and stores the results in the area designated by the argument.
Arguments	Address of the area for storing the A/D conversion results
Return value	None
Remarks	None

5.6 Flowcharts

Figure 5.1 shows the overall flow of the sample program described in this application note.

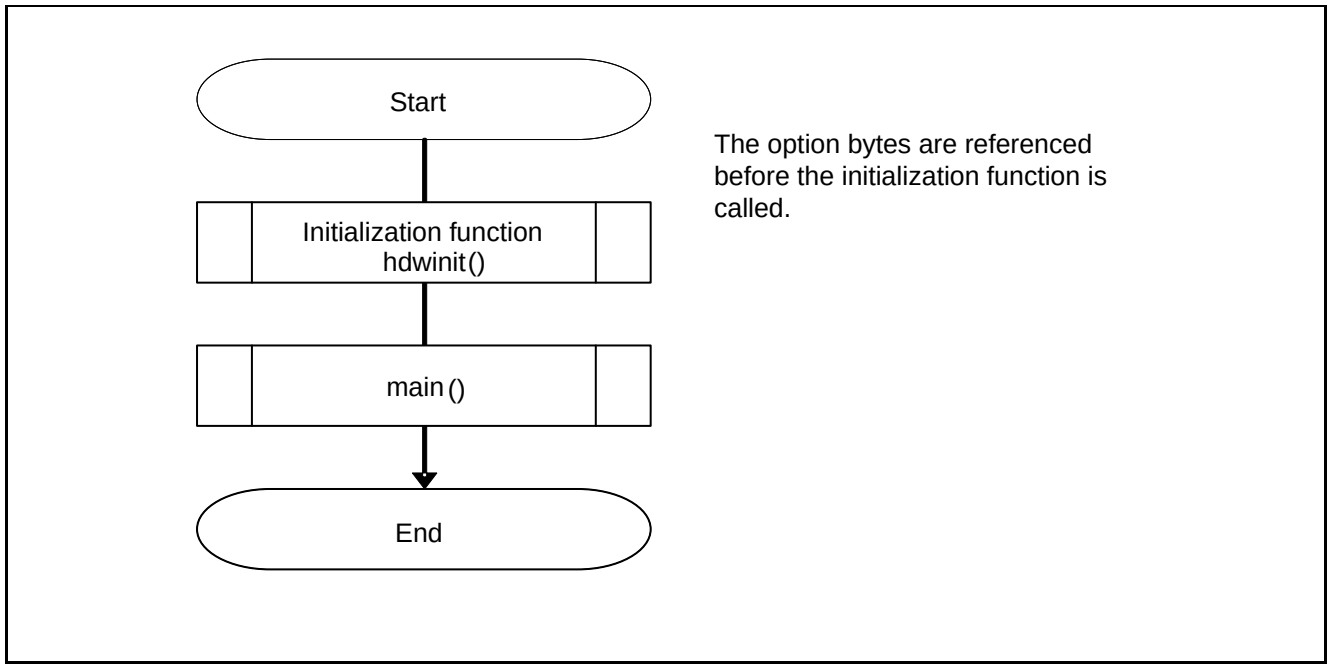

Figure 5.1 Overall Flow

Note: Startup routine is executed before and after the initialization function.

5.6.1 Initialization Function

Figure 5.2 shows the flowchart for the initialization function.

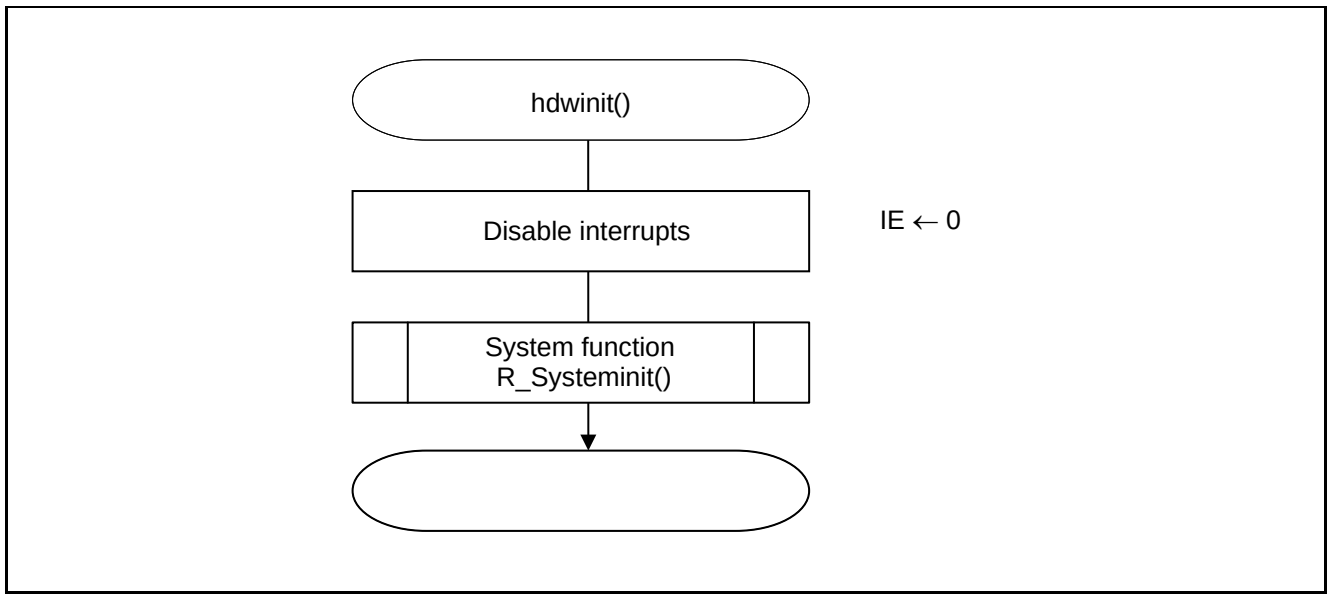

Figure 5.2 Initialization Function

5.6.2 System Function

Figure 5.3 shows the flowchart for the system function.

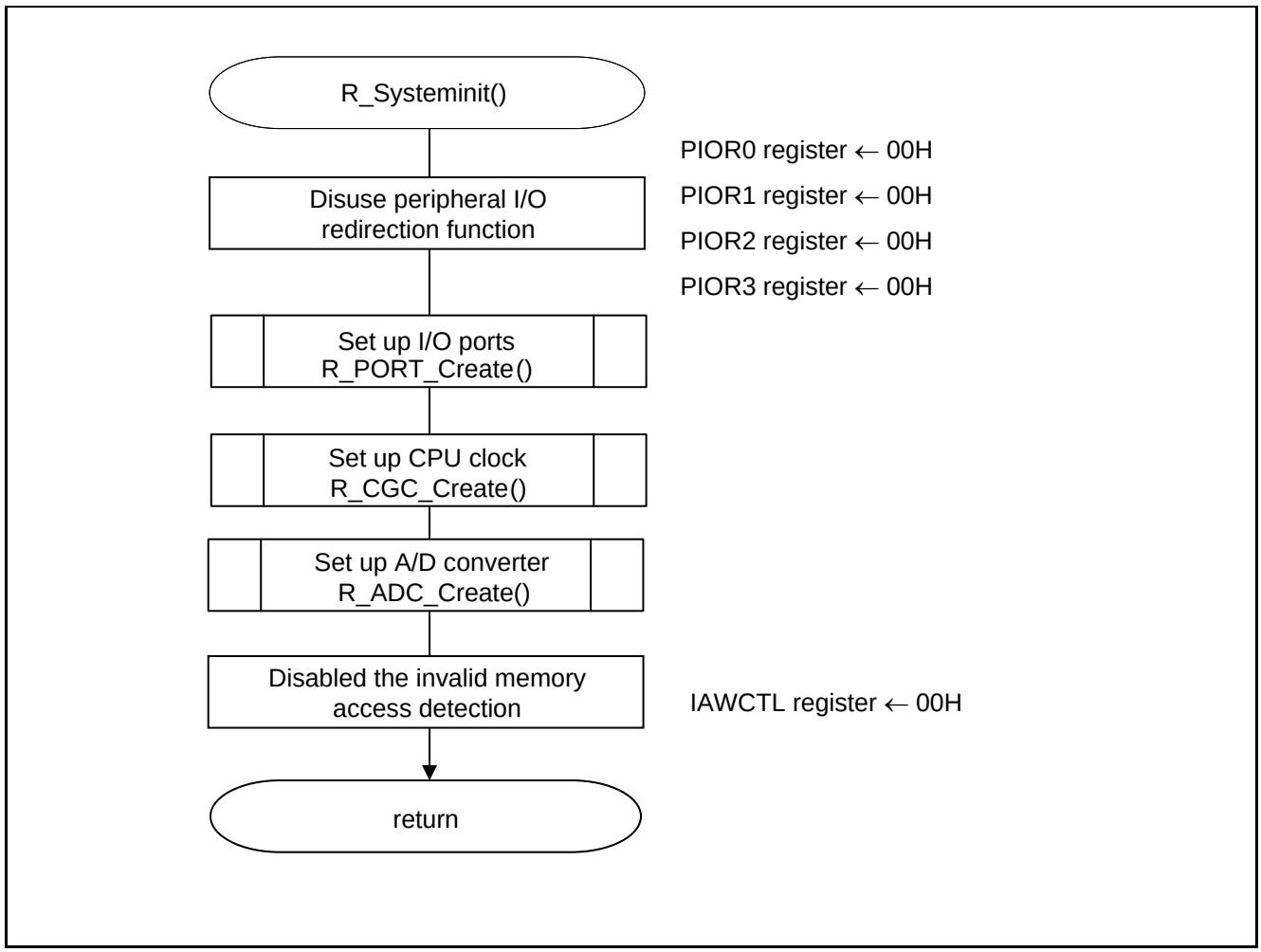

Figure 5.3 System Function

5.6.3 I/O Port Setup

Figure 5.4 shows the flowchart for I/O port setup.

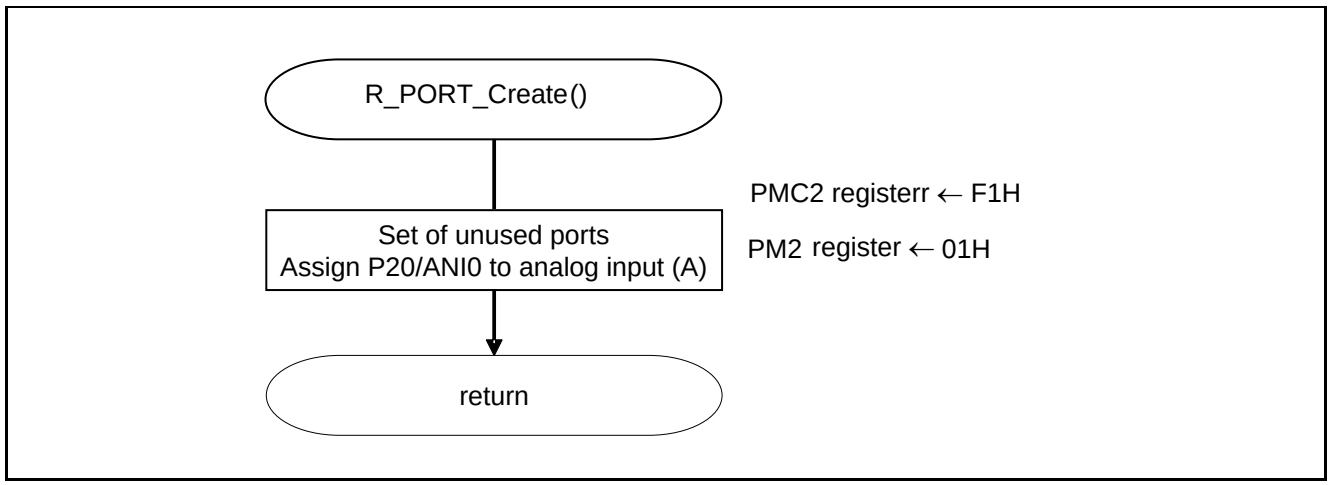

Figure 5.4 I/O Port Setup

Note: Refer to RL78/G11 User's Manual: Hardware (R01UH0637E) for the configuration of the unused ports.

Note: Provide proper treatment for unused pins so that their electrical specifications are observed. Connect each of any unused input-only ports to V_{DD} or V_{SS} via separate resistors.

- Port mode control register 2 (PMC2)
- Port mode register 2 (PM2)
  Selects the I/O mode of each port.

Setting up the channel to be used for A/D conversion

Symbol: PMC2

7	6	5	4	3	2	1	0
1	1	1	1	PMC23	PMC22	PMC21	PMC20
1	1	1	1	x	x	x	**1**

Bit 0

PMC20	PMC20 pin digital I/O/analog input selection
0	Digital I/O (altenate function other than analog input)
1	**Analog input**

Symbol: PM2

7	6	5	4	3	2	1	0
1	1	1	1	PM23	PM22	PM21	PM20
1	1	1	1	x	x	x	**1**

Bit 0

PM20	PM20 I/O Mode Select
0	Output mode (output buffer on)
1	**Input mode (output buffer off)**

Note: For details on the procedure for setting up the registers, refer to RL78/G11 User's Manual: Hardware.

5.6.4 CPU Clock Setup

Figure 5.5 shows the flowchart for setting up the CPU clock.

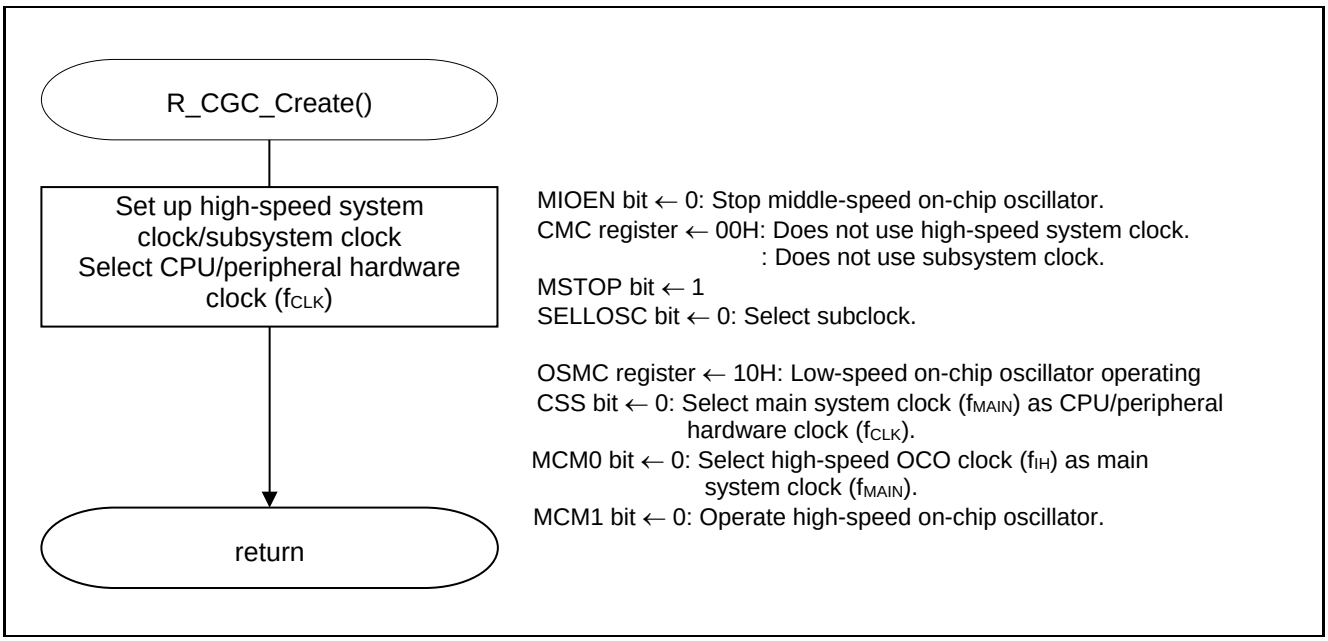

Figure 5.5 CPU Clock Setup

Note: For details on the procedure for setting up the CPU clock (R_CGC_Create ()), refer to the section entitled "Flowcharts" in RL78/G11 User's Manual: Hardware (R01UH0637E).

5.6.5 Setting up the A/D Converter

Figure 5.6 shows the flowchart for setting up the A/D converter.

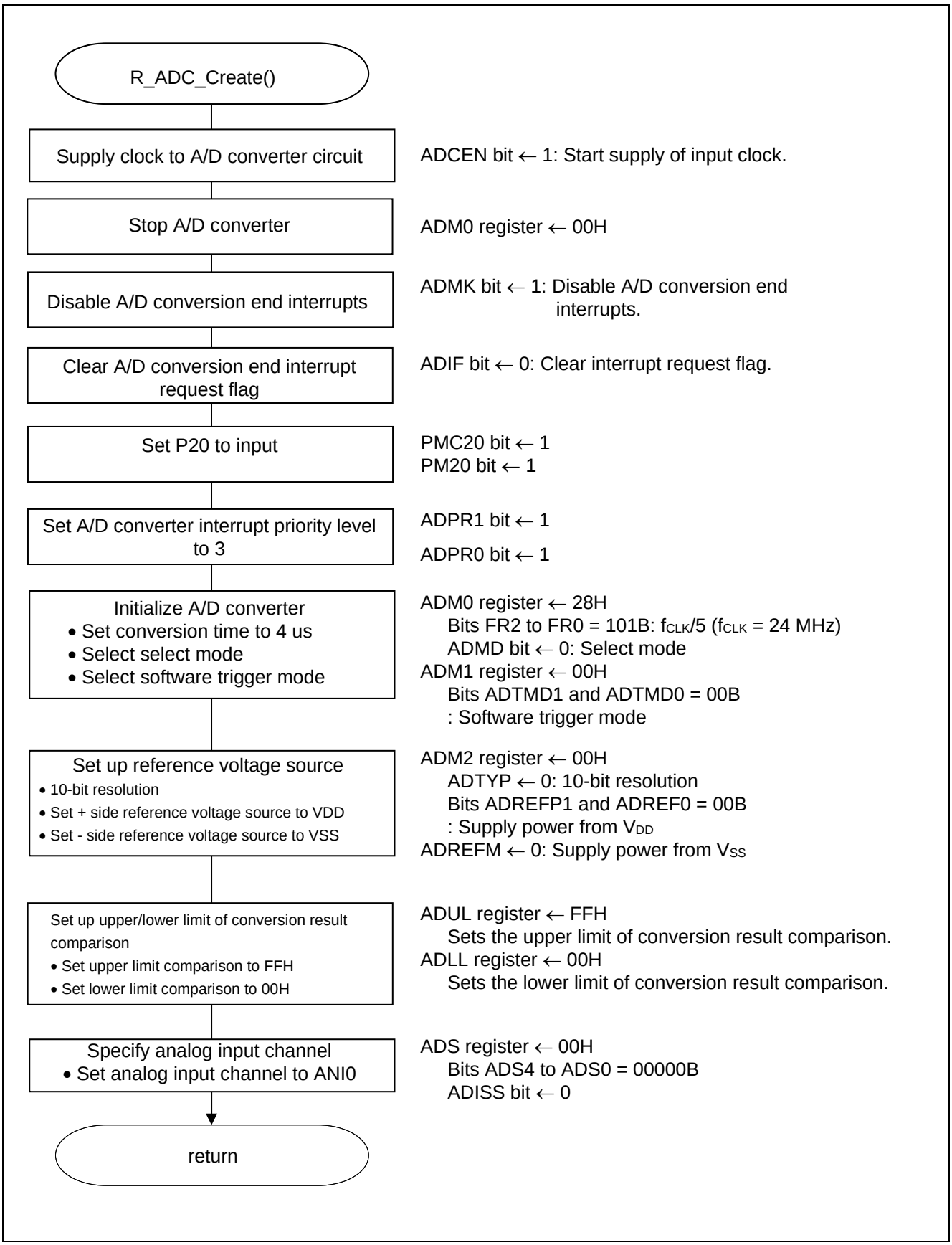

Figure 5.6 A/D Converter Setup Flowchart

Starting the supply of clock to the A/D converter

- Peripheral enable register 0 (PER0)
  Starts the supply of the clock to the A/D converter.

Symbol: PER0

7	6	5	4	3	2	1	0
0	IICA1EN	ADCEN	IICA0EN	0	SAU0EN	0	TAU0EN
0	0	**1**	x	0	x	0	x

Bit 5

ADCEN	A/D converter input clock control
0	Stops supply of input clock.
1	**Starts supply of input clock.**

Note: For details on the register setup procedures, refer to RL78/G11 User's Manual: Hardware.

Setting up the A/D conversion time and operation mode

- A/D converter mode register 0 (ADM0)
  Controls the A/D conversion operation.
  Specifies the A/D conversion channel selection mode.

Symbol: ADM0

7	6	5	4	3	2	1	0
ADCS	ADMD	FR2	FR1	FR0	LV1	LV0	ADCE
x	**0**	**1**	**0**	**1**	**0**	**0**	x

Bit 6

ADMD	A/D channel selection mode select
0	**Select mode**
1	Scan mode

Bits 5 to 1

ADM0					Mode	Conversion Clock (f_{AD})	No. of conv. clock (Sampling clock)	Conversion Time	Conversion Time Selection				
FR2	FR1	FR0	LV1	LV0					f_{CLK} = 1 MHz	f_{CLK} = 4 MHz	f_{CLK} = 8 MHz	f_{CLK} = 16 MHz	f_{CLK} = 24 MHz
0	0	0	0	0	Standard 1	$f_{CLK}/64$	**19 f_{AD} (number of Sampling clock: 7 f_{AD})**	$1216/f_{CLK}$	Setting prohibited	Setting prohibited	Setting prohibited	76 µs	50.667 µs
0	0	1				$f_{CLK}/32$		$608/f_{CLK}$			76 µs	38 µs	25.333 µs
0	1	0				$f_{CLK}/16$		$304/f_{CLK}$		76 µs	38 µs	19 µs	12.667 µs
0	1	1				$f_{CLK}/8$		$152/f_{CLK}$		38 µs	19 µs	9.5 µs	6.333 µs
1	0	0				$f_{CLK}/6$		$114/f_{CLK}$		28.5 µs	14.25 µs	7.125 µs	4.75 µs
1	**0**	**1**				**$f_{CLK}/5$**		**$96/f_{CLK}$**	95 µs	23.75 µs	11.875 µs	5.938 µs	**3.958 µs**
1	1	0				$f_{CLK}/4$		$76/f_{CLK}$	76 µs	19 µs	9.5 µs	4.75 µs	3.167 µs
1	1	1				$f_{CLK}/2$		$38/f_{CLK}$	38 µs	9.5 µs	4.75 µs	2.375 µs	Setting prohibited
0	0	0	0	1	Standard 2	$f_{CLK}/64$	17 f_{AD} (number of Sampling clock: 5 f_{AD})	$1088/f_{CLK}$	Setting prohibited	Setting prohibited	Setting prohibited	68 µs	45.333 µs
0	0	1				$f_{CLK}/32$		$544/f_{CLK}$			68 µs	34 µs	22.667 µs
0	1	0				$f_{CLK}/16$		$272/f_{CLK}$		68 µs	34 µs	17 µs	11.333 µs
0	1	1				$f_{CLK}/8$		$136/f_{CLK}$		34 µs	17 µs	8.5 µs	5.667 µs
1	0	0				$f_{CLK}/6$		$102/f_{CLK}$		25.5 µs	12.75 µs	6.375 µs	4.25 µs
1	0	1				$f_{CLK}/5$		$85/f_{CLK}$	85 µs	21.25 µs	10.625 µs	5.3125 µs	3.542 µs
1	1	0				$f_{CLK}/4$		$68/f_{CLK}$	68 µs	17 µs	8.5 µs	4.25 µs	2.833 µs
1	1	1				$f_{CLK}/2$		$34/f_{CLK}$	34 µs	8.5 µs	4.25 µs	2.125 µs	Setting prohibited

Note: For details on the register setup procedures, refer to RL78/G11 User's Manual: Hardware.

Setting up the A/D conversion trigger mode

- A/D converter mode register 1 (ADM1)
  Selects the A/D conversion trigger mode.
  Selects the A/D conversion mode.

Symbol: ADM1

7	6	5	4	3	2	1	0
ADTMD1	ADTMD0	ADSCM	0	0	0	ADTRS1	ADTRS0
0	**0**	**0**	0	0	0	**0**	**0**

Bits 7 and 6

ADTMD1	ADTMD0	Selection of the A/D conversion trigger mode
0	**—**	**Software trigger mode**
1	0	Hardware trigger no-wait mode
1	1	Hardware trigger wait mode

Bit 5

ADSCM	Specification of the A/D conversion mode
0	**Sequential conversion mode**
1	One-shot conversion mode

Bits 1 and 0

ADTRS1	ADTRS0	Selection of the hardware trigger signal
0	**0**	**End of timer channel 1 count or capture interrupt signal (INTTM01)**
0	1	Setting prohibited
1	0	Setting prohibited
1	1	12-bit interval timer interrupt signal (INTIT)

Note: For details on the register setup procedures, refer to RL78/G11 User's Manual: Hardware.

Setting up the reference voltage

- A/D converter mode register 2 (ADM2)
  Sets up the reference voltage source.

Symbol: ADM2

7	6	5	4	3	2	1	0
ADREFP1	ADREFP0	ADREFM	0	ADCRK	AWC	0	ADTYP
0	**0**	**0**	0	**0**	**0**	0	**0**

Bits 7 and 6

ADREFP1	ADREFP0	Selection of the + side reference voltage source of the A/D converter
0	**0**	**Supplied from V_{DD}.**
0	1	Supplied from P20/AV_{REFP}/ANI0.
1	0	Supplied from internal reference voltage (1.45 V).
1	1	Setting prohibited

Bit 5

ADREFM	Selection of the − side reference voltage source of the A/D converter
0	**Supplied from V_{SS}.**
1	Supplied from P21/AV_{REFM}/ANI1.

Bit 3

ADCRK	Checking the upper limit and lower limit conversion result values
0	**The interrupt signal (INTAD) is output when the ADLL register ≤ the ADCR register ≤ the ADUL register.**
1	Interrupt signal (INTAD) is output when ADCR register < ADLL register and ADUL register < ADCR register.

Bit 2

AWC	Specification of the wakeup function (SNOOZE mode)
0	**Do not use the SNOOZE mode function.**
1	Use the SNOOZE mode function.

Bit 0

ADTYP	Selection of the A/D conversion resolution
0	**10-bit resolution**
1	8-bit resolution

Note: For details on the register setup procedures, refer to RL78/G11 User's Manual: Hardware.

Setting up the conversion result comparison upper limit/lower limit

- Conversion result comparison upper limit setting register (ADUL)
- Conversion result comparison lower limit setting register (ADLL)
  Sets up the conversion result comparison upper- and lower-limit

Symbol: ADUL

7	6	5	4	3	2	1	0
ADUL7	ADUL6	ADUL5	ADUL4	ADUL3	ADUL2	ADUL1	ADUL0
1	**1**	**1**	**1**	**1**	**1**	**1**	**1**

Symbol: ADLL

7	6	5	4	3	2	1	0
ADLL7	ADLL6	ADLL5	ADLL4	ADLL3	ADLL2	ADLL1	ADLL0
0	**0**	**0**	**0**	**0**	**0**	**0**	**0**

Specifying the input channel

- Analog input channel specification register (ADS)
  Specifies the input channel for the analog voltage to be subjected to A/D conversion.

Symbol: ADS

7	6	5	4	3	2	1	0
ADISS	0	0	ADS4	ADS3	ADS2	ADS1	ADS0
0	0	0	**0**	**0**	**0**	**0**	**0**

Bits 7, 4 to 0

ADISS	ADS4	ADS3	ADS2	ADS1	ADS0	Analog Input Channel	Input Source
0	**0**	**0**	**0**	**0**	**0**	**ANI0**	**P20/ANI0 pin/AV_{REFP} pin**
0	0	0	0	0	1	ANI1	P21/ANI1 pin/AV_{REFM} pin
0	0	0	0	1	0	ANI2	P22/ANI2 pin
0	0	0	0	1	1	ANI3	P23/ANI3 pin
0	1	0	0	0	0	ANI16	P01/ANI16 pin
0	1	0	0	0	1	ANI17	P00/ANI17 pin
0	1	0	0	1	0	ANI18	P33/ANI18 pin
0	1	0	0	1	1	ANI19	P32/ANI19 pin
0	1	0	1	0	0	ANI20	P31/ANI20 pin
0	1	0	1	0	1	ANI21	P30/ANI21 pin
0	1	0	1	1	0	ANI22	P56/ANI22 pin
0	1	0	1	1	1	—	PGAOUT
1	0	0	0	0	0	—	Temperature sensor 0 output
1	0	0	0	0	1	—	Internal reference voltage output (1.45 V)
Other than above						Setting prohibited	

Note: For details on the register setup procedures, refer to RL78/G11 User's Manual: Hardware.

Setting up end of A/D conversion interrupts

- Interrupt request flag register (IF1H)
  Clears the interrupt request flag.
- Interrupt mask flag register (MK1H)
  Disables interrupts.

Symbol: IF1H

7	6	5	4	3	2	1	0
PIF11	PIF10	PIF9	PIF8	PIF7	KRIF	TMKAIF	ADIF
x	x	x	x	x	x	x	**0**

Bit 0

ADIF	Interrupt request flag
0	**No interrupt request signal is generated.**
1	Interrupt request is generated, interrupt request status

Symbol: MK1H

7	6	5	4	3	2	1	0
PMK11	PMK10	PMK9	PMK8	PMK7	KRMK	TMKAMK	ADMK
x	x	x	x	x	x	x	**1**

Bit 0

ADMK	Interrupt processing control
0	Enables interrupt processing.
1	**Disables interrupt processing.**

Note: For details on the register setup procedures, refer to RL78/G11 User's Manual: Hardware.

5.6.6 Main Processing

Figure 5.7 shows the flowchart for the main processing routine.

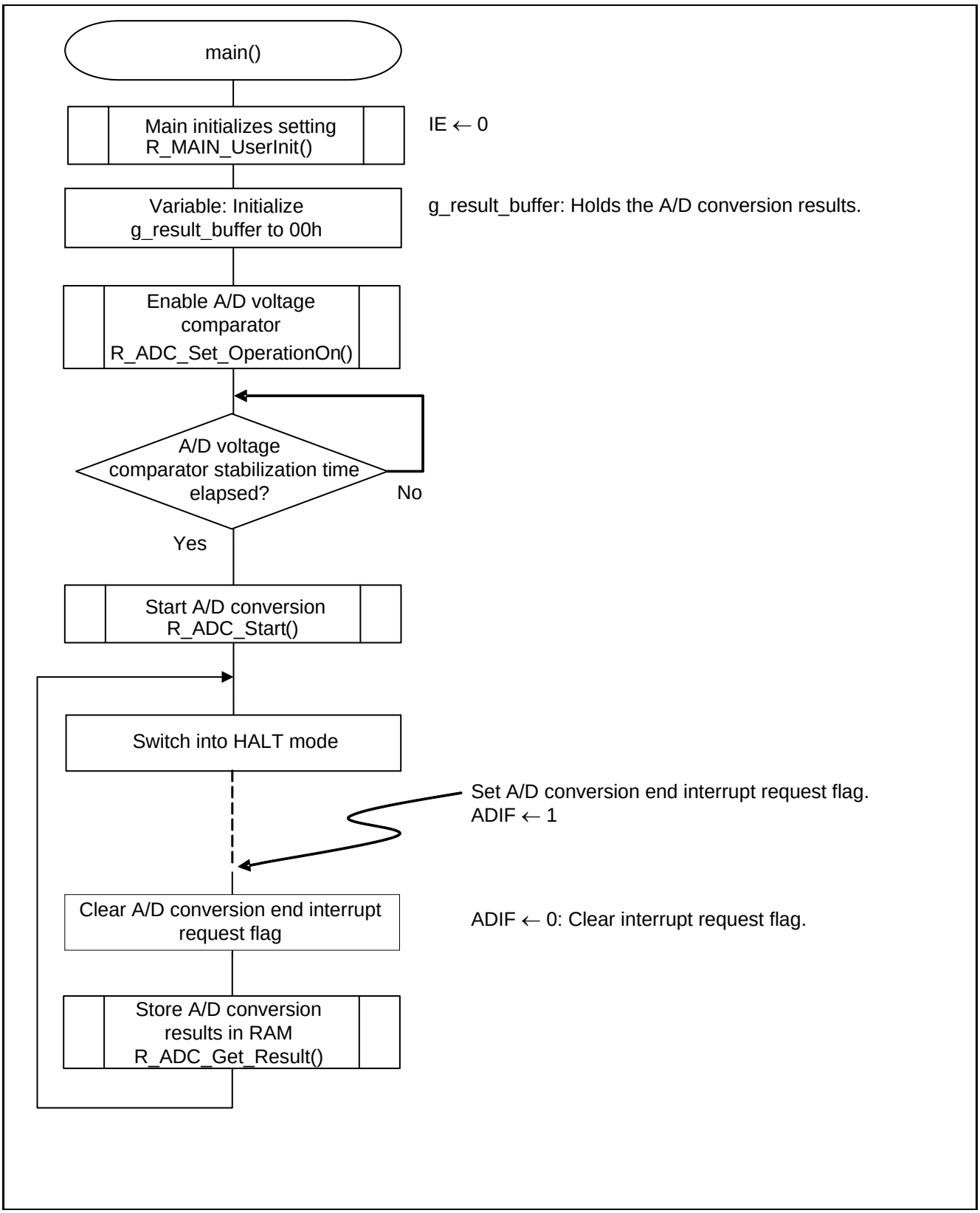

Figure 5.7 Main Processing

5.6.7 Main initializes settings

Figure 5.8 shows the flowchart for the main initializes settings.

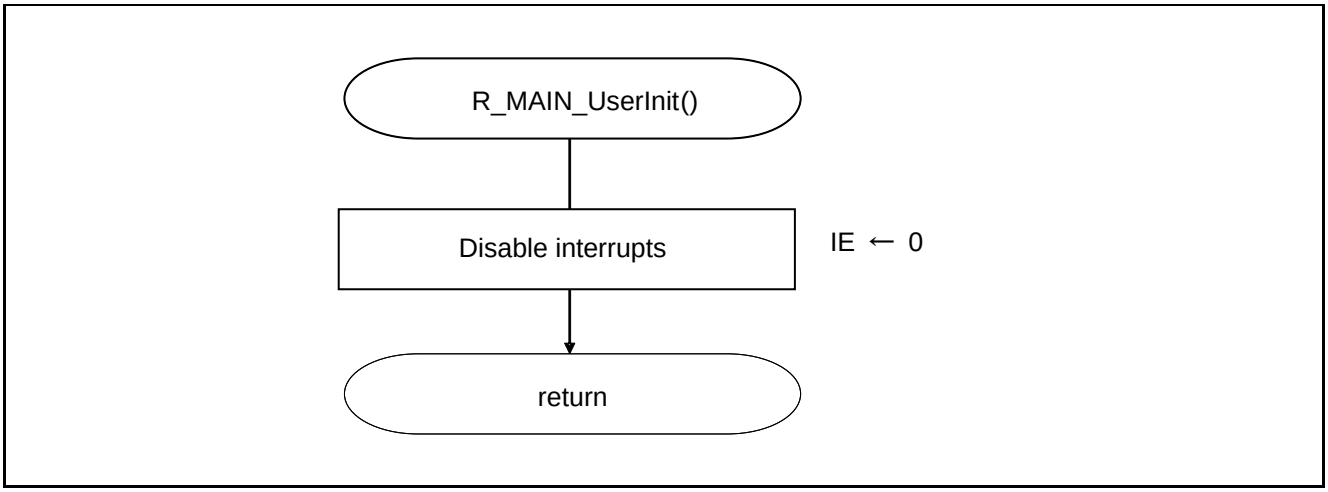

Figure 5.8 Main initializes settings

5.6.8 Enabling the A/D Voltage Comparator

Figure 5.9 shows the flowchart for enabling the A/D voltage comparator.

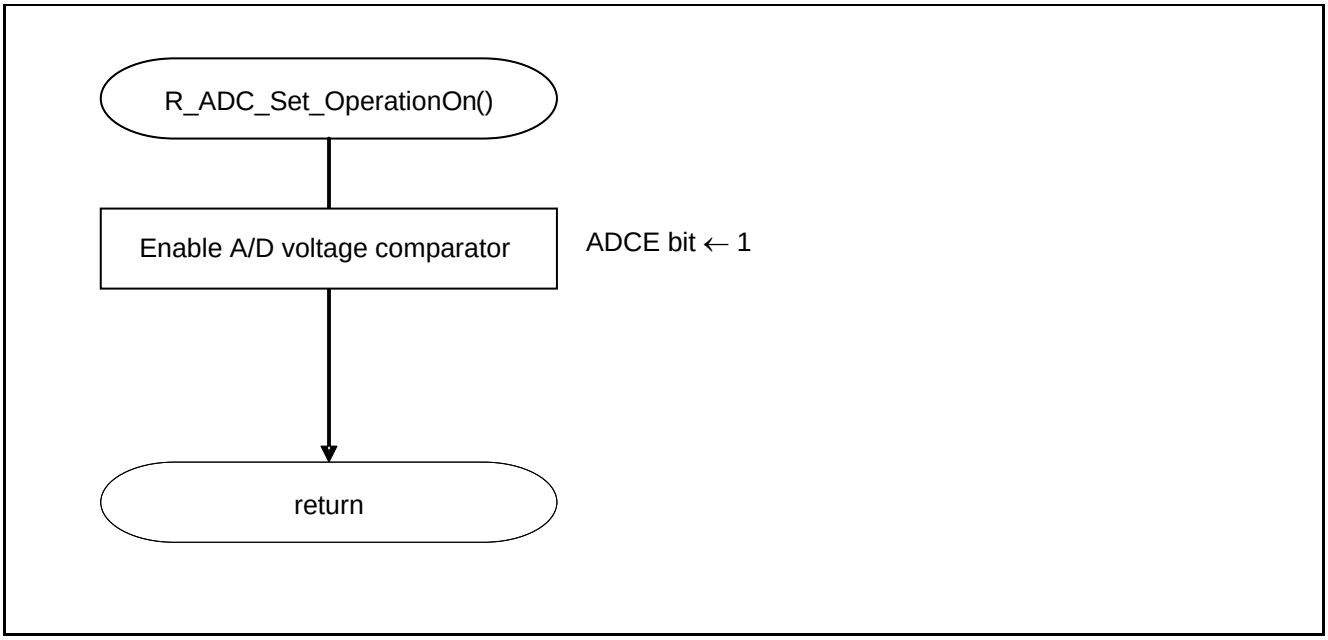

Figure 5.9 Enabling the A/D Voltage Comparator

Starting the A/D voltage comparator

- A/D converter mode register 0 (ADM0)
  Controls the operation of the A/D voltage comparator.

Symbol: ADM0

7	6	5	4	3	2	1	0
ADCS	ADMD	FR2	FR1	FR0	LV1	LV0	ADCE
x	x	x	x	x	x	x	**1**

Bit 0

ADCE	A/D voltage comparator operation control
0	Stops A/D voltage comparator operation.
1	**Enables A/D voltage comparator operation.**

Note: For details on the register setup procedures, refer to RL78/G11 User's Manual: Hardware.

5.6.9 Starting A/D Conversion

Figure 5.10 shows the flowchart for starting A/D conversion processing.

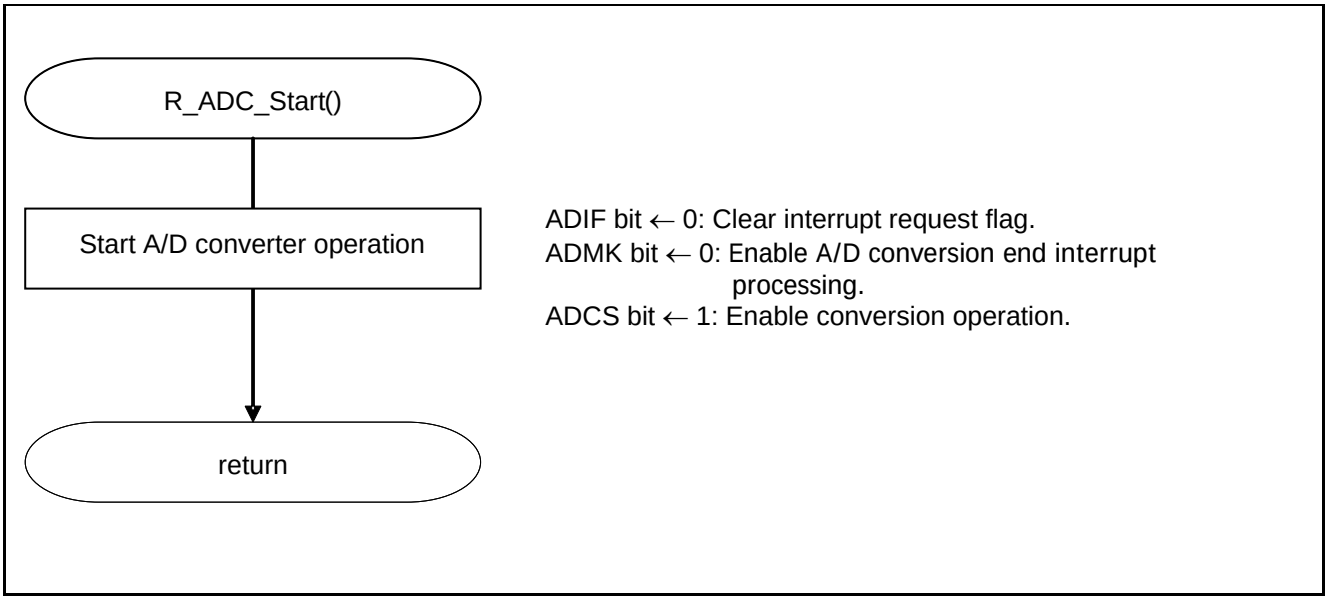

Figure 5.10 Starting A/D Conversion

Starting conversion operation

- A/D converter mode register 0 (ADM0)
  Controls the A/D conversion operation.

Symbol: ADM0

7	6	5	4	3	2	1	0
ADCS	ADMD	FR2	FR1	FR0	LV1	LV2	ADCE
1	x	x	x	x	x	x	1

Bit 7

ADCS	A/D conversion operation control
0	Stops conversion operation.
1	**Enables conversion operation.**

Note: For details on the register setup procedures, refer to RL78/G11 User's Manual: Hardware.

5.6.10 Storing A/D Conversion Results in RAM

Figure 5.11 shows the flowchart for storing the A/D conversion results in RAM.

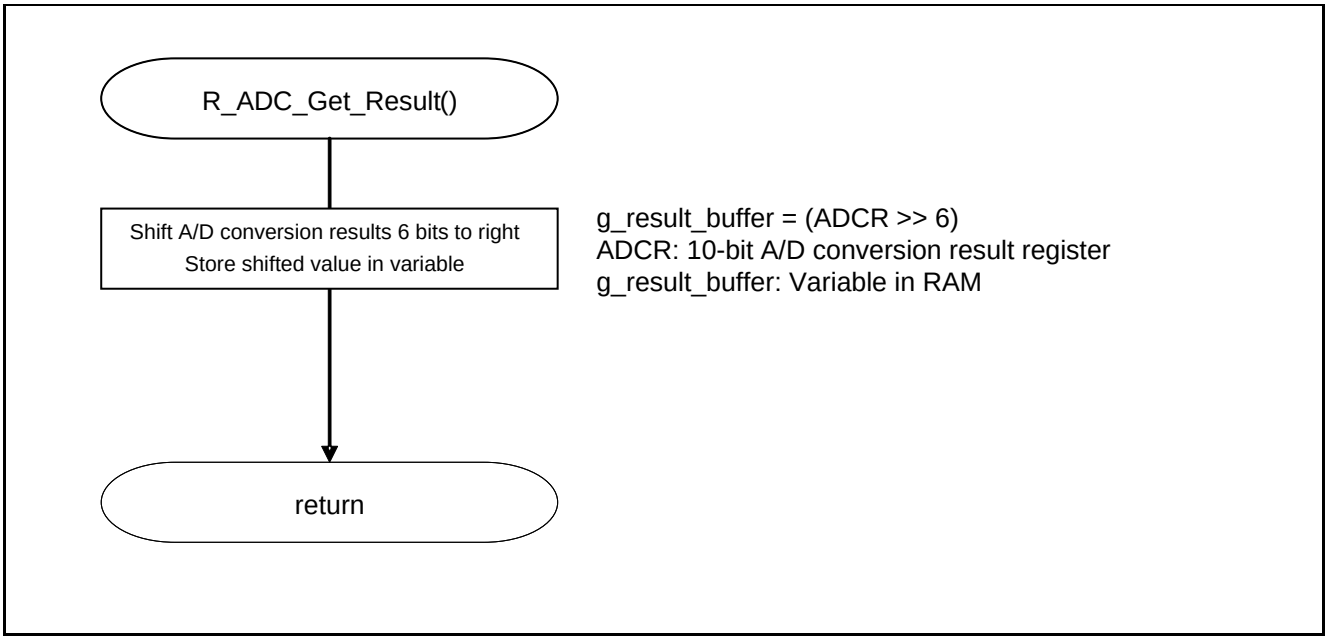

Figure 5.11 Storing the A/D Conversion Results in RAM

6. Sample Code

The sample code is available on the Renesas Electronics Website.

7. Documents for Reference

User's Manual:

RL78/G11 User's Manual: Hardware (R01UH0637E)
RL78 Family User's Manual: Software (R01US0015E)
The latest version can be downloaded from the Renesas Electronics website.

Technical Updates/Technical News

The latest information can be downloaded from the Renesas Electronics website.

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http://www.renesas.com/index.jsp

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REVISION HISTORY	RL78/G11 A/D Converter (Software Trigger and Sequential Conversion Modes) CC-RL

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General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

   A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.
2. Processing at power-on

   The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.
3. Input of signal during power-off state

   Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.
4. Handling of unused pins

   Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.
5. Clock signals

   After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.
6. Voltage application waveform at input pin

   Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).
7. Prohibition of access to reserved addresses

   Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.
8. Differences between products

   Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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